

DESCRIPTION

The TLP521, TLP521-2 and TLP521-4 series of optically coupled isolator consist of an infrared light emitting diode and an NPN silicon photo transistor in a space efficient Dual In Line Plastic Package.

FEATURES

- AC Isolation Voltage 5300V_{RMS}
- CTR Selections Available
- Wide Operating Temperature Range -30°C to +100°C
- Lead Free and RoHS Compliant
- UL File E91231 Package Code "EE"
- VDE Approval Certificate No. 40028086

APPLICATIONS

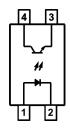
- Computer Terminals
- Industrial System Controllers
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

ORDER INFORMATION

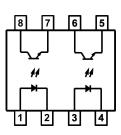
- Add X after PN for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel (Available for TLP521SM and TLP521-2SM)
- Optional Order Part No. TLP521-1 for TLP521
- Consult Factory for Tape and Reel version of TLP521-4SM

ROHS V

TLP521

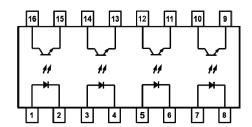


TLP521-2



- 1 Anode
- 2 Cathode
- 3 Emitter
- 4 Collector
- 1, 3 Anode
- 2, 4 Cathode
- 5. 7 Emitter
- 6. 8 Collector

TLP521-4



1, 3, 5, 7 Anode 2, 4, 6, 8 Cathode 9, 11, 13, 15 Emitter 10, 12, 14, 16 Collector

ISOCOM COMPONENTS 2004 LTD

Unit 25B, Park View Road West, Park View Industrial Estate Hartlepool, Cleveland, TS25 1PE, United Kingdom Tel: +44 (0)1429 863 609 Fax: +44 (0)1429 863 581 e-mail: sales@isocom.co.uk

http://www.isocom.com

ISOCOM COMPONENTS ASIA LTD

Hong Kong Office
Block A, 8/F, Wah Hing Industrial Mansion
36 Tai Yau Street, San Po Kong, Kowloon, Hong Kong
Tel: +852 2995 9217 Fax: +852 8161 6292
e-mail: sales@isocom.com.hk



ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

Forward Current 50mA 6V Reverse Voltage Power dissipation 70mW

Output

Collector to Emitter Voltage BV_{CEO} 55V Emitter to Collector Voltage BV_{ECO} 6V Collector Current 50mA **Power Dissipation** 150mW

Total Package

Isolation Voltage 5300V_{RMS} **Total Power Dissipation** 200mW -30 to 100 °C **Operating Temperature** -55 to 125 °C Storage Temperature

125 °C Junction Temperature Lead Soldering Temperature (10s) 260°C

ISOCOM COMPONENTS 2004 LTD

Unit 25B, Park View Road West, Park View Industrial Estate Hartlepool, Cleveland, TS25 1PE, United Kingdom Tel: +44 (0)1429 863 609 Fax: +44 (0)1429 863 581 e-mail: sales@isocom.co.uk http://www.isocom.com

ISOCOM COMPONENTS ASIA LTD

Hong Kong Office Block A, 8/F, Wah Hing Industrial Mansion 36 Tai Yau Street, San Po Kong, Kowloon, Hong Kong Tel: +852 2995 9217 Fax: +852 8161 6292 e-mail: sales@isocom.com.hk



ELECTRICAL CHARACTERISTICS (Ambient Temperature = 25°C unless otherwise specified)

INPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	V_{F}	$I_F = 10 \text{mA}$	1.0	1.15	1.3	V
Reverse Voltage	V_R	$I_R = 10\mu A$	6.0			V
Reverse Leakage	I_R	$V_R = 4V$			10	μΑ
Terminal Capacitance	C_{t}	V = 0V, $f = 1KHz$		30	250	pF

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector—Emitter breakdown Voltage	BV _{CEO}	$I_C = 0.5 \text{mA}, I_F = 0 \text{mA}$	55			V
Emitter—Collector breakdown Voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_E = 100 \mu A, I_F = 0 mA$	6			V
Collector-Emitter Dark Current	I_{CEO}	$V_{CE} = 20V$, $I_F = 0mA$			100	nA



ELECTRICAL CHARACTERISTICS (Ambient Temperature = 25°C unless otherwise specified)

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current Transfer Ratio	CTR	$I_F = 5 \text{mA}, V_{CE} = 5 \text{V}$	50		600	%
		$\begin{array}{c} \text{Optional CTR Grades} \\ \text{GR} \\ \text{BL} \\ \text{GB} \\ \text{GB (I}_F = 1 \text{mA, V}_{CE} = 0.4 \text{V}) \end{array}$	100 200 100 30		300 600 600	
Collector—Emitter Saturation Voltage	V _{CE(sat)}	$I_F = 8mA, I_C = 2.4mA$ GB ($I_F = 1mA, I_C = 0.2mA$)			0.4 0.4	V
Output Rise Time	$t_{\rm r}$	$V_{CE} = 2V$, Ic = 2mA,		4		μs
Output Fall Time	t_{f}	$R_L = 100\Omega$		3		
Turn-on Time	t _{on}			3		
Turn-off Time	$t_{\rm off}$			3		
Turn-on Time	t_{ON}	$V_{CC}=5V$, $I_F=16\text{mA}$,		2		μs
Turn-off Time	t_{OFF}	$R_{L} = 1.9k\Omega$		25		

ISOLATION

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Input to Output Isolation Voltage	$V_{\rm ISO}$	R.H. = 40% to 60 %, t = 1 min	5300			V_{RMS}
Input to Output Resistance	$R_{\rm ISO}$	$V_{IO} = 500 VDC$, R.H. = 40% to 60 %,	5 x 10 ¹⁰			Ω

Device is considered a two terminal device: Input pins are shorted together and Output pins are shorted together.



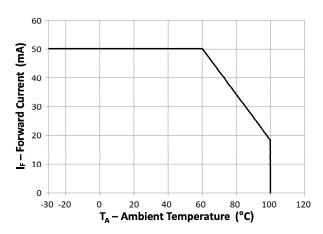


Fig 1 Forward Current vs TA

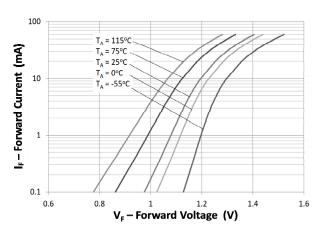


Fig 3 Forward Current vs Forward Voltage

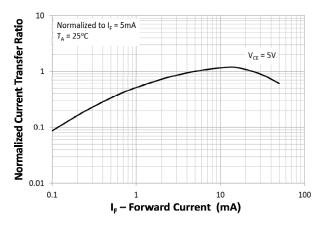


Fig 5 Normalized Current Transfer Ratio vs Forward Current

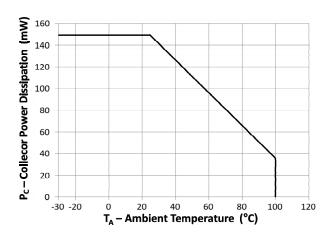


Fig 2 Collector Power Dissipation vs T_A

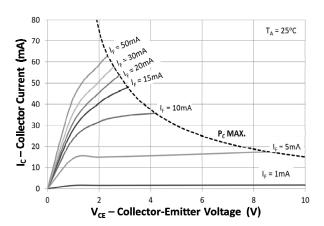


Fig 4 Collector Current vs Collector-Emitter Voltage

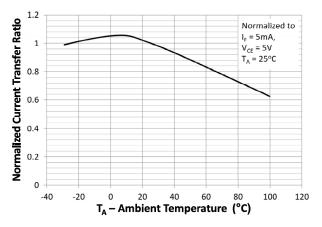


Fig 6 Normalized Current Transfer Ratio vs Ambient Temperature



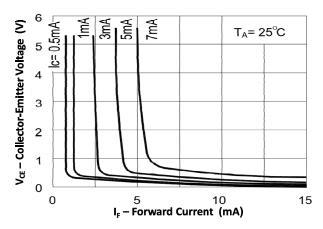


Fig 7 Collector-Emitter Voltage vs Forward Current

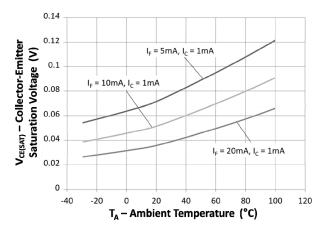


Fig 8 Collector-Emitter Voltage vs Ambient Temperature

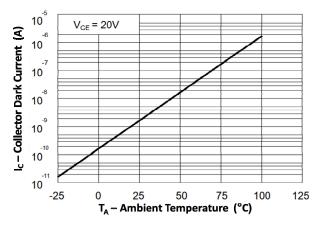


Fig 9 Collector Dark Current vs Ambient Temperture



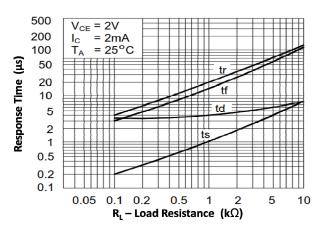
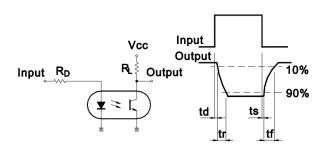


Fig 10 Response Time vs Load Resistance



Response Time Test Circuit

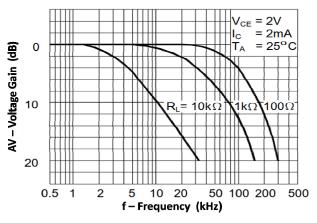
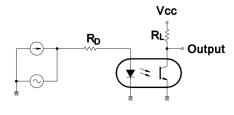


Fig 11 Frequency Response



Frequency Response Test Circuit



ORDER INFORMATION

	TLP521, TLP521-1 (UL Approval)					
After PN	PN	Description	Packing quantity			
None	TLP521, TLP521-1 TLP521GR, TLP521-1GR TLP521BL, TLP521-1BL, TLP521GB, TLP521-1GB	Standard DIP4	100 pcs per tube			
G	TLP521G, TLP521-1G, TLP521GRG, TLP521-1GRG, TLP521BLG, TLP521-1BLG TLP521GBG, TLP521-1GBG	10mm Lead Spacing	100 pcs per tube			
SM	TLP521SM, TLP521-1SM, TLP521GRSM, TLP521-1GRSM, TLP521BLSM, TLP521-1BLSM, TLP521GBSM, TLP521-1GBSM	Surface Mount	100 pcs per tube			
SMT&R	TLP521SMT&R, TLP521-1SMT&R TLP521GRSMT&R, TLP521-1GRSMT&R, TLP521BLSMT&R, TLP521-1BLSMT&R, TLP521-GBSMT&R, TLP521-1GBSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

Note: Optional Order Part No. TLP521-1 for TLP521.

Devices with suffix "X" (UL and VDE approvals) may be supplied when ordering the above Part Numbers (UL approval only).



ORDER INFORMATION

	TLP521-2 (UL Approval)					
After PN	PN	Description	Packing quantity			
None	TLP521-2, TLP521-2GR, TLP521-2BL, TLP521-2GB	Standard DIP8	50 pcs per tube			
G	TLP521-2G, TLP521-2GRG, TLP521-2BLG, TLP521-2GBG	10mm Lead Spacing	50 pcs per tube			
SM	TLP521-2SM, TLP521-2GRSM, TLP521-2BLSM, TLP521-2GBSM	Surface Mount	50 pcs per tube			
SMT&R	TLP521-2SMT&R, TLP521-2GRSMT&R, TLP521-2BLSMT&R, TLP521-2GBSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

TLP521-4 (UL Approval)				
After PN	PN	Description	Packing quantity	
None	TLP521-4, TLP521-4GR, TLP521-4BL, TLP521-4GB	Standard DIP16	25 pcs per tube	
G	TLP521-4G, TLP521-4GRG, TLP521-4BLG, TLP521-4GBG	10mm Lead Spacing	25 pcs per tube	
SM	TLP521-4SM, TLP521-4GRSM, TLP521-4BLSM, TLP521-4GBSM	Surface Mount	25 pcs per tube	

Note: Devices with suffix "X" (UL and VDE approvals) may be supplied when ordering the above Part Numbers (UL approval only).



ORDER INFORMATION

	TLP521X, TLP521-1X (UL and VDE Approvals)				
After PN	PN	Description	Packing quantity		
None	TLP521X, TLP521-1X TLP521XGR, TLP521-1XGR TLP521XBL, TLP521-1XBL, TLP521XGB, TLP521-1XGB	Standard DIP4	100 pcs per tube		
G	TLP521XG, TLP521-1XG, TLP521XGRG, TLP521-1XGRG, TLP521XBLG, TLP521-1XBLG TLP521XGBG, TLP521-1XGBG	10mm Lead Spacing	100 pcs per tube		
SM	TLP521XSM, TLP521-1XSM, TLP521XGRSM, TLP521-1XGRSM, TLP521XBLSM, TLP521-1XBLSM, TLP521XGBSM, TLP521-1XGBSM	Surface Mount	100 pcs per tube		
SMT&R	TLP521XSMT&R, TLP521-1XSMT&R TLP521XGRSMT&R, TLP521-1XGRSMT&R, TLP521XBLSMT&R, TLP521-1XBLSMT&R, TLP521-1XGBSMT&R, TLP521-1XGBSMT&R,	Surface Mount Tape & Reel	1000 pcs per reel		

Note: Optional Order Part No. TLP521-1X for TLP521X.



ORDER INFORMATION

	TLP521-2X (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	TLP521-2X, TLP521-2XGR, TLP521-2XBL, TLP521-2XGB	Standard DIP8	50 pcs per tube			
G	TLP521-2XG, TLP521-2XGRG TLP521-2XBLG, TLP521-2XGBG	10mm Lead Spacing	50 pcs per tube			
SM	TLP521-2XSM, TLP521-2XGRSM, TLP521-2XBLSM, TLP521-2XGBSM	Surface Mount	50 pcs per tube			
SMT&R	TLP521-2XSMT&R, TLP521-2XGRSMT&R, TLP521-2XBLSMT&R, TLP521-2XGBSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

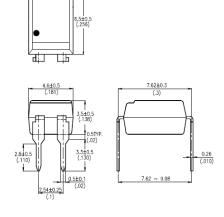
TLP521-4X (UL and VDE Approvals)				
After PN	PN	Description	Packing quantity	
None	TLP521-4X, TLP521-4XGR, TLP521-4XBL, TLP521-4XGB	Standard DIP16	25 pcs per tube	
G	TLP521-4XG, TLP521-4XGRG, TLP521-4XBLG, TLP521-4XGBG	10mm Lead Spacing	25 pcs per tube	
SM	TLP521-4XSM, TLP521-4XGRSM, TLP521-4XBLSM, TLP521-4XGBSM	Surface Mount	25 pcs per tube	



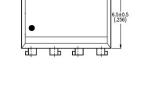
PACKAGE DIMENSIONS in mm (inch)

DIP

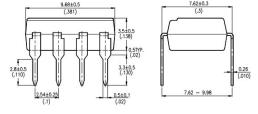
TLP521



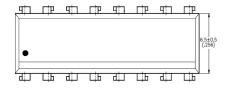
TLP521-2

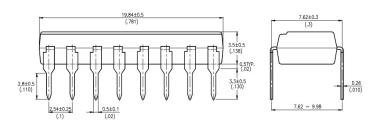


97 (72 97) (72



TLP521-4



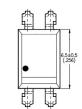


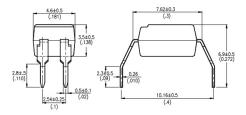


PACKAGE DIMENSIONS in mm (inch)

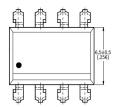
G Form

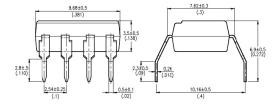
TLP521G



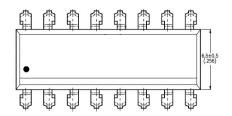


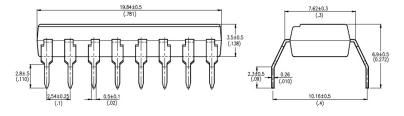
TLP521-2G





TLP521-4G



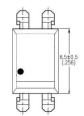


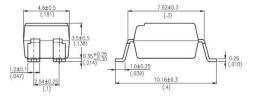


PACKAGE DIMENSIONS in mm (inch)

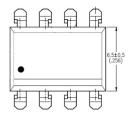
SMD

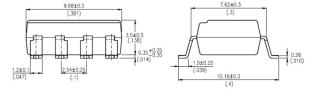
TLP521SM



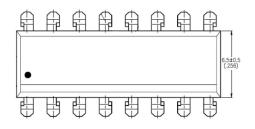


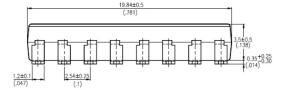
TLP521-2SM

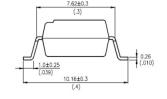




TLP521-4SM



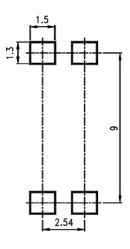




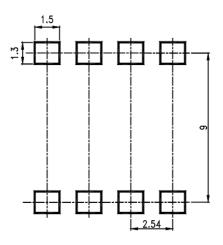


RECOMMENDED PAD LAYOUT FOR SMD (mm)

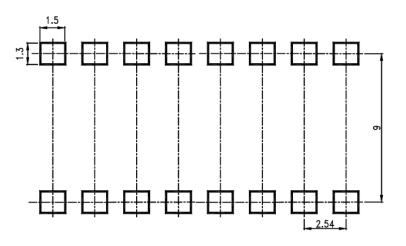




TLP521-2SM

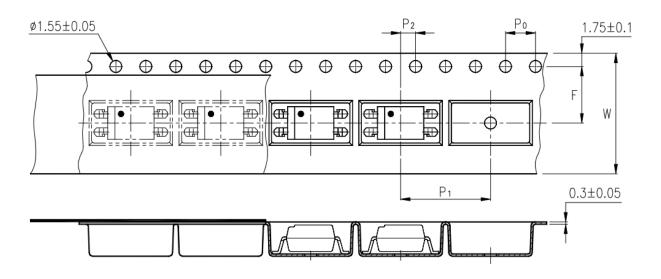


TLP521-4SM

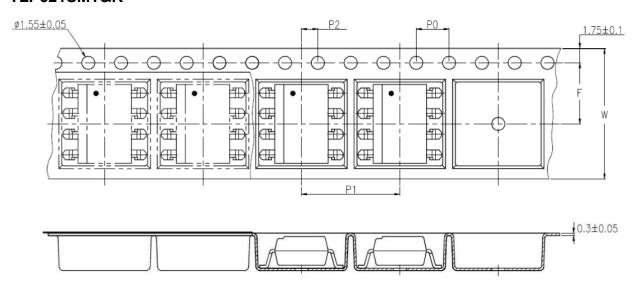




TAPE AND REEL PACKAGING



TLP521SMT&R

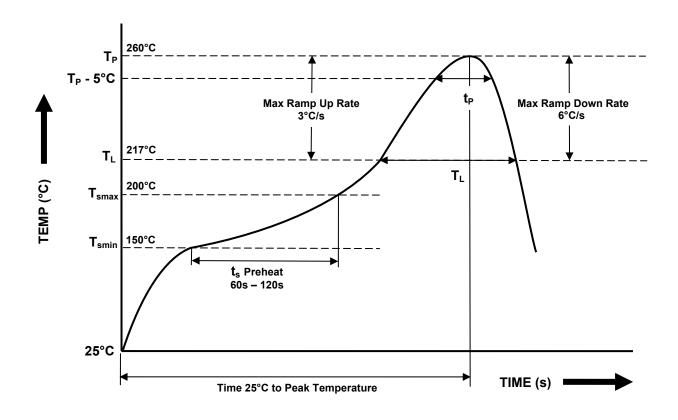


TLP521-2SMT&R

Description	Symbol	Dimensions in mm (inches)
Tape wide	W	$16 \pm 0.3 (.63)$
Pitch of sprocket holes	P ₀	4 ± 0.1 (.15)
Distance of commontment	F	$7.5 \pm 0.1 (.295)$
Distance of compartment	P ₂	$2 \pm 0.1 (.079)$
Distance of compartment to compartment	P1	12 ± 0.1 (.472)



IR REFLOW SOLDERING TEMPERATURE PROFILE FOR SMD (One Time Reflow Soldering is Recommended)



Profile Details	Conditions
$ \begin{array}{l} \textbf{Preheat} \\ \textbf{- Min Temperature } (T_{SMIN}) \\ \textbf{- Max Temperature } (T_{SMAX}) \\ \textbf{- Time } T_{SMIN} \text{ to } T_{SMAX} \left(t_s\right) \end{array} $	150°C 200°C 60s - 120s
$\begin{tabular}{ll} \textbf{Soldering Zone} \\ - & \begin{tabular}{ll} - & \begin{tabular}{ll} \textbf{Peak Temperature } & \begin{tabular}{ll} - & \begin{tabular}{ll} \textbf{Peak Temperature } & \begin{tabular}{l$	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T _{smax} to T _P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



DISCLAIMER

Isocom Components is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing Isocom Components products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such Isocom Components products could cause loss of human life, bodily injury or damage to property.

In developing your designs, please ensure that Isocom Components products are used within specified operating ranges as set forth in the most recent Isocom Components products specifications.

The Isocom Components products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These Isocom Components products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation Instruments, traffic signal instruments, combustion control instruments, medical Instruments, all types of safety devices, etc... Unintended Usage of Isocom Components products listed in this document shall be made at the customer's own risk.

Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

The products described in this document are subject to the foreign exchange and foreign trade laws.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by Isocom Components for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of Isocom Components or others.

The information contained herein is subject to change without notice.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for isocom manufacturer:

Other Similar products are found below:

SFH615A-2SM H11A1 MOC3021M ISD74X IS60SM MOC3043X ICPL4503SM PS2505-4 MOCD207 IS60SMT&R MOC3083

MOC3081M ICPL2531SM PS2502-2 IS341W SFH617A-4X MOC3043M PS2502-2SM ILQ74X ICPL2601 IS181C PS2502-4SM

ICPL2530SM MOC3021XSM MOC3041SM ISQ74X CNY17-2XSM CNY17-1XSM MOC3023M H11AA1XSM ISQ2X PS2505-4SM

TIL199 4N32FSM 4N35X MOC3020X H21A3 IS281C MOC3061X ISP817B MOC3041M ILQ1XSM 4N25X MOC3022X MOC3021X

CNY17-3X ISP521-1XSM ISP06SM PS2805-1 TLP321-4XGB